ALPHA & OMEGA SEMICONDUCTOR

AO4420A
N-Channel Enhancement Mode Field Effect Transistor

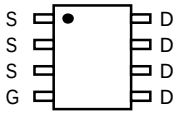
General Description

The AO4420A uses advanced trench technology to provide excellent $R_{DS(ON)}$, shoot-through immunity and body diode characteristics.This device is suitable for use as a synchronous switch in PWM applications. *Standard Product AO4420A is Pb-free (meets ROHS & Sony 259 specifications).*

Features

V_{DS} (V) = 30V
I_D = 13.7A (V_{GS} = 10V)
$R_{DS(ON)}$ < 10.5mΩ (V_{GS} = 10V)
$R_{DS(ON)}$ < 12mΩ (V_{GS} = 4.5V)

UIS Tested
Rg,Ciss,Coss,Crss Tested



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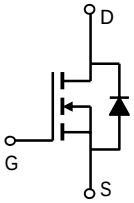

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current [AF]	T_A=25°C	I_D	13.7	A
	T_A=70°C		9.7	
Pulsed Drain Current [B]		I_{DM}	60	
Avalanche Current [B]		I_{AR}	20	A
Repetitive avalanche energy L=0.3mH [B]		E_{AR}	60	mJ
Power Dissipation	T_A=25°C	P_D	3.1	W
	T_A=70°C		2	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient [A]	t ≤ 10s	$R_{\theta JA}$	28	40	°C/W
Maximum Junction-to-Ambient [A]	Steady-State		54	75	°C/W
Maximum Junction-to-Lead [C]	Steady-State	$R_{\theta JL}$	21	30	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=250µA, V_{GS}=0V	30			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=24V, V_{GS}=0V		0.004	1	µA
		T_J=55°C			5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}= ±12V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS} I_D=250µA	0.6	1.1	2	V
$I_{D(ON)}$	On state drain current	V_{GS}=4.5V, V_{DS}=5V	40			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, ID=13.7A		8.3	10.5	mΩ
		T_J=125°C		12.5	15	
		V_{GS}=4.5V, I_D=12.7A		9.7	12	mΩ
g_{FS}	Forward Transconductance	V_{DS}=5V, I_D=13.7A	30	37		S
V_{SD}	Diode Forward Voltage	I_S=1A,V_{GS}=0V		0.76	1	V
I_S	Maximum Body-Diode Continuous Current				5	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=15V, f=1MHz		3656	4050	pF
C_{oss}	Output Capacitance			256		pF
C_{rss}	Reverse Transfer Capacitance			168		pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz		0.86	1.1	Ω
SWITCHING PARAMETERS						
Q_g(4.5V)	Total Gate Charge	V_{GS}=4.5V, V_{DS}=15V, I_D=13.7A		30.5	36	nC
Q_{gs}	Gate Source Charge			4.6		nC
Q_{gd}	Gate Drain Charge			8.6		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DS}=15V, R_L=1.1Ω, R_{GEN}=3Ω		5.5	9	ns
t_r	Turn-On Rise Time			3.4	7	ns
$t_{D(off)}$	Turn-Off DelayTime			49.8	75	ns
t_f	Turn-Off Fall Time			5.9	11	ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=13.7A, dI/dt=100A/µs		22.5	28	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=13.7A, dI/dt=100A/µs		12.5	16	nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in ^{2} FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ^{2} FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating.

F.The current rating is based on the t ≤ 10s thermal resistance rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

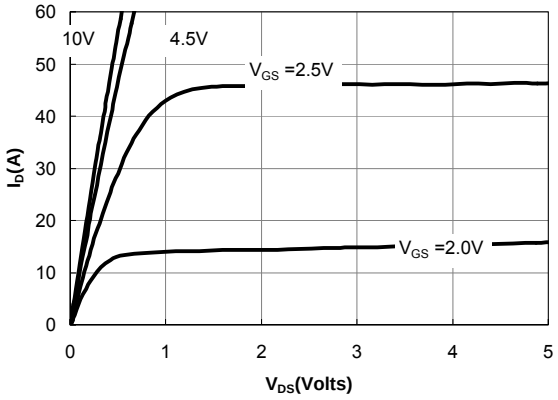

Figure 1: On-Regions CharacteristiCS

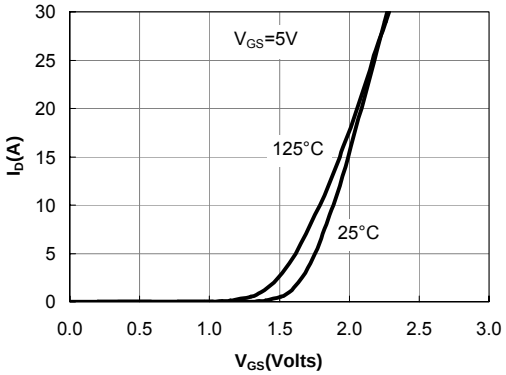

Figure 2: Transfer Characteristics

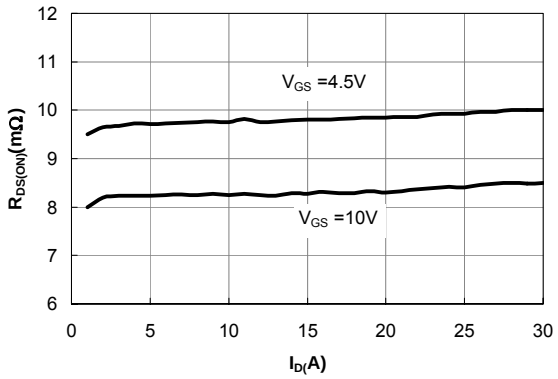

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

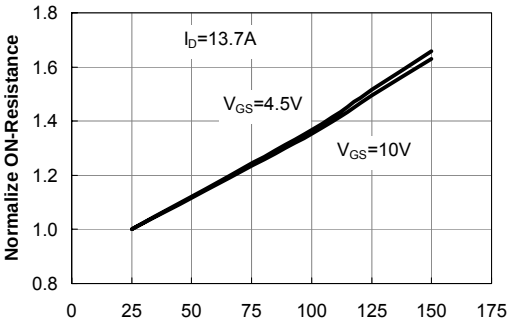

Figure 4: On-Resistance vs. Junction Temperature

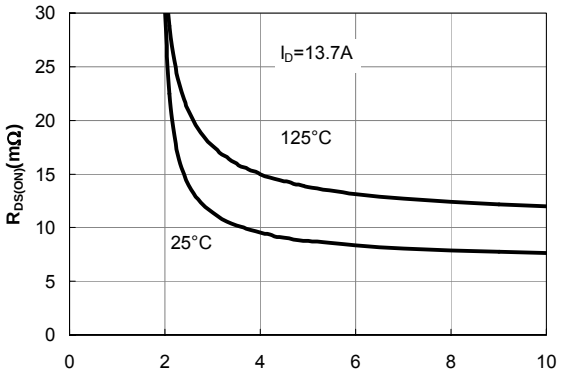

Figure 5: On-Resistance vs. Gate-Source Voltage

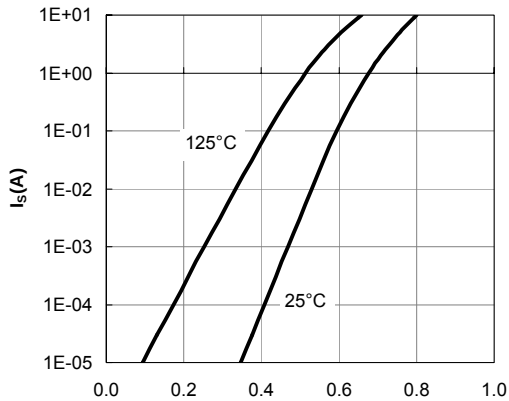

Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

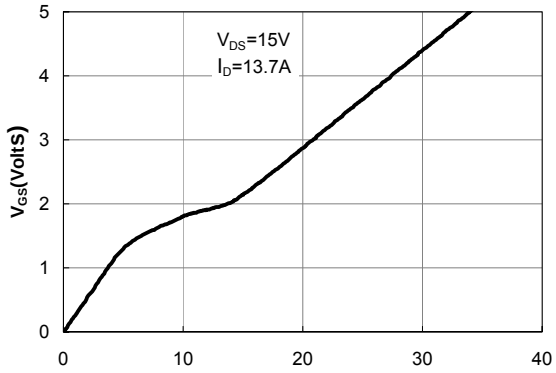

Figure 7: Gate-Charge Characteristics

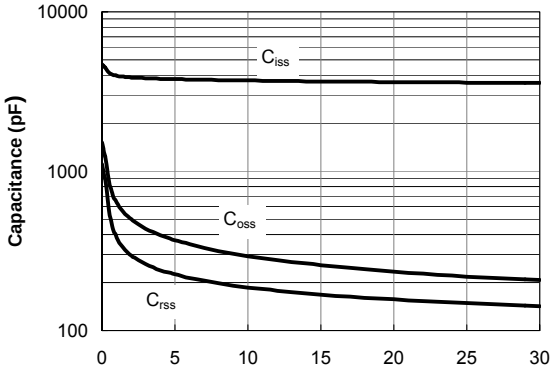

Figure 8: Capacitance Characteristics

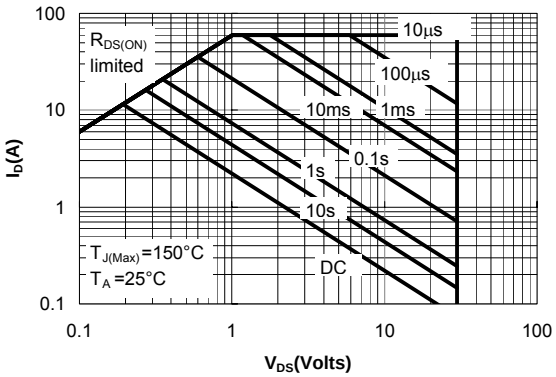

Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

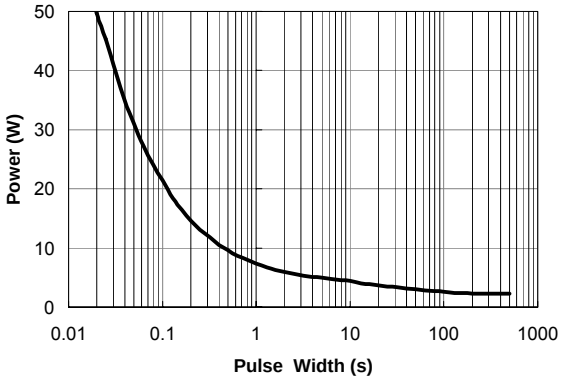

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

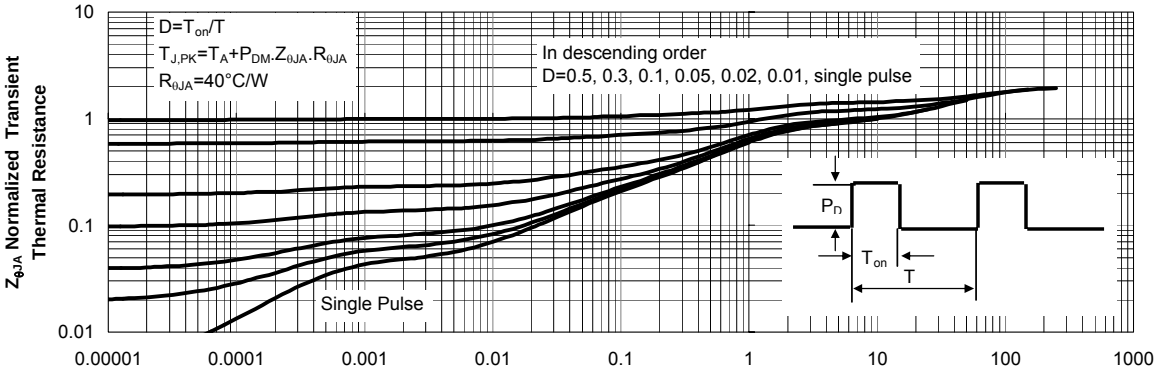

Figure 11: Normalized Maximum Transient Thermal Impedence